PCN	Number:	2016052300	14		PCN Date:		Sept. 14, 2016		
Title: Datasheet for UCC28180		ren bate.			Эсри 14, 2010				
	tomer Contact:	PCN Manager				De	pt: Quality Services		
	nge Type:	I CIT Manager				DC	Quality Services		
	Assembly Site			Design			Wafer Bump Site		
	Assembly Process		Data Sheet			<u> </u>	Wafer Bump Material		
H	Assembly Material	c	Part number change		change	H	Wafer Bump Process		
$\forall$	Mechanical Specifi		Test Site		change	$\overline{H}$	Wafer Fab Site		
Ħ	Packing/Shipping/		Test Process			Ħ	Wafer Fab Materials		
							Wafer Fab Process		
Notification Details									
Des	cription of Chang	e:							
	as Instruments Inco		nno	ouncing an in	formation onl	y no	tification.		
The	product datasheet(	(s) is being up	oda	ted as summ	arized below.				
	6 11		_						
The	following change h	istory provide	es t	urther details	5.				
J	TEXAS								
7	Texas Instruments						UCC28180		
_				_	SLUSBQ	5D – NC	OVEMBER 2013-REVISED JULY 2016		
C	hanges from Revision C (	April 2016) to Revi	isio	n D			Page		
•	Changed the correct page	e number in the C F	Revis	sion History of the	diode addition to the	e Fun	ctional Block Diagram 2		
•	Changed text value of 0.5			· ·					
•							he D revision		
<u>.</u>	Added Receiving Notifica	tion of Documentati	ion l	Jpdates					
С	hanges from Revision B (	December 2014) to	o Re	vision C			Page		
•	Added a diode to the Typ	ical Application Sch	nema	atic image			1		
•	Changed ICC Standby cu	ırrent MAX rate fron	n 2.9	95 mA to 3.47 mA.			6		
•	Changed ISENSE thresh	old, soft over curren	nt (S	OC) TYP value fro	m -0.295 V to -0.2	85 V.	6		
•	Changed Maximum curre	nt under EDR opera	atior	MAX rating from	–241 μA to –275 μ <i>Α</i>	۹	6		
•		•					13		
•	Added Diode to Soft Ove	rcurrent/Peak-Curre	ent L	imit image			17		
•	Added ISENSE Pin section.								
•	Added diode to the Design Example Schematic image. 22								
•	- · · · · · · · · · · · · · · · · · · ·								
<u>.</u>	Changed Recommended	Layout for UCC281	180 i	mage					
The	datasheet number	will be changi	ina						
	vice Family	will be clially	y	Change Fro	m'		Change To:		
	C28180			SLUSBQ5B			SLUSBQ5D		
00	C20100			SEOSDQSD			32030Q30		
Tho	so shangos may ho	ravioused at t	·ha	datachoot lin	uke provided				
These changes may be reviewed at the datasheet links provided. <a href="http://www.ti.com/product/UCC28180">http://www.ti.com/product/UCC28180</a>									
Intep.//www.ti.com/product/occzoroo									
Reason for Change:									
To more accurately reflect device characteristics.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
No anticipated impact. This is a specification change announcement only. There are no changes									
to the actual device.									

Changes to product identification resulting from this PCN:								
None.								
Product Affected:								
UCC28180D	UCC28180DR							

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
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